

L Number	Hits	Search Text	DB	Time stamp
1	42	"6330102"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:12
2	671380	oscillat\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:12
3	2	"6330102" and oscillat\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:13
4	3809	Mems and mirror\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:16
5	798	oscillat\$5 and (Mems and mirror\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:16
6	192325	oscillating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:17
7	354	(Mems and mirror\$1) and oscillating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:17
8	106	((Mems and mirror\$1) and oscillating) and bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:27
9	2192	oscillating adj mirror\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:27
10	103	(oscillating adj mirror\$1) and MEMS	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:36
11	316	micromachined adj device	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:36
12	27324	second adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:37

13	17	(micromachined adj device) and (second adj substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/14 16:37

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Active

L1: (42) "6330102"

L2: (671380) oscillat\$5

L3: (2) 1 and 2

L4: (3809) Mem\$ and mirror\$1

L5: (798) 2 and 4

L6: (192325) oscillating

L7: (354) 4 and 6

L8: (106) 7 and bonding

L9: (2192) oscillating adj mirror\$1

L10: (103) 9 and MEMS

L11: (316) micromachined adj device

L12: (27324) second adj substrate

L13: (17) 11 and 12

USPAT:US POPUL:EPD:JPD:DERWENT:BM:108

11 and 12

7/14/04

	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	Retrieval Cla	Inventor	S	C	P	3	Image 1
1	<input type="checkbox"/>	<input type="checkbox"/>	US 20040130442	20040708	224	Wireless and powerless sensor and interrogator	340/443	340/449		Breed, David S. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2004
2	<input type="checkbox"/>	<input type="checkbox"/>	US 20040087053	20040506	9	Low cost fabrication and assembly of lid for semiconductor devices	438/51	438/127		Lytle, William H. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2004
3	<input type="checkbox"/>	<input type="checkbox"/>	US 20040056275	20040325	12	Process for manufacturing a micromachined oscillating element in MEMS control chip integration	257/200			Murari, Bruno et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2004
4	<input type="checkbox"/>	<input type="checkbox"/>	US 20040016995	20040129	17		257/678			Kuo, Shun Meen et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2004
5	<input type="checkbox"/>	<input type="checkbox"/>	US 20040009614	20040115	26	Magnetic bead-based arrays	436/526	422/58		Ahn, Chong H et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2004
6	<input type="checkbox"/>	<input type="checkbox"/>	US 20030230798	20031218	20	Wafer level MEMS packaging	257/704	257/E21.499; 257/E23.114		Lin, Jong-Kai et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2003
7	<input type="checkbox"/>	<input type="checkbox"/>	US 20030118277	20030626	25	Digital optical switch apparatus and process for manufacturing same	385/18	385/16		Yu, Duli et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2003
8	<input type="checkbox"/>	<input type="checkbox"/>	US 20020179921	20021205	24	Compliant hermetic package	257/99	257/E21.511; 257/E23.193;		Cohn, Michael B.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2002
9	<input type="checkbox"/>	<input type="checkbox"/>	US 20020175079	20021128	21	Device and method for the manipulation of a fluid sample	204/601	204/450; 204/451;		Christel, Lee A. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2002
10	<input type="checkbox"/>	<input type="checkbox"/>	US 20020172969	20021121	59	Chip-based isothermal amplification devices and methods	435/6	435/287.2; 435/293.1		Burns, Mark A. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2002
11	<input type="checkbox"/>	<input type="checkbox"/>	US 20020168671	20021114	60	Chip-based isothermal amplification devices and methods	435/6	435/287.2; 435/293.1		Burns, Mark A. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 2002
12	<input type="checkbox"/>	<input type="checkbox"/>	US 6626039 B1	20030930	23	Electrically decoupled silicon gyroscope	73/504.04	73/504.08; 73/504.11;		Adams, Scott G. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 6626
13	<input type="checkbox"/>	<input type="checkbox"/>	US 6379929 B1	20020430	56	Chip-based isothermal amplification devices and methods	435/91.2	435/91.1; 436/501		Burns, Mark A. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 6379
14	<input type="checkbox"/>	<input type="checkbox"/>	US 5847631 A	19981208	18	Magnetic relay system and method capable of microfabrication products	335/78	257/415; 29/622;		Taylor, William P. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 5847
15	<input type="checkbox"/>	<input type="checkbox"/>	US 5668319 A	19970916	16	Micromachined accelerometer	73/514.09	73/514.06; 73/654		Garabedian, Raffi	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 5668
16	<input type="checkbox"/>	<input type="checkbox"/>	US 5640995 A	19970624	26	Electrofluidic standard module and custom circuit board assembly	137/597	137/884; 251/129.1		Packard, Warren J. et al.	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	US 5640

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